

The growth of $\text{Cs}_3\text{Cu}_2\text{Br}_5$ and CsCu_2Br_3 single crystals by cooling crystallization for scintillator application

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Supporting Information

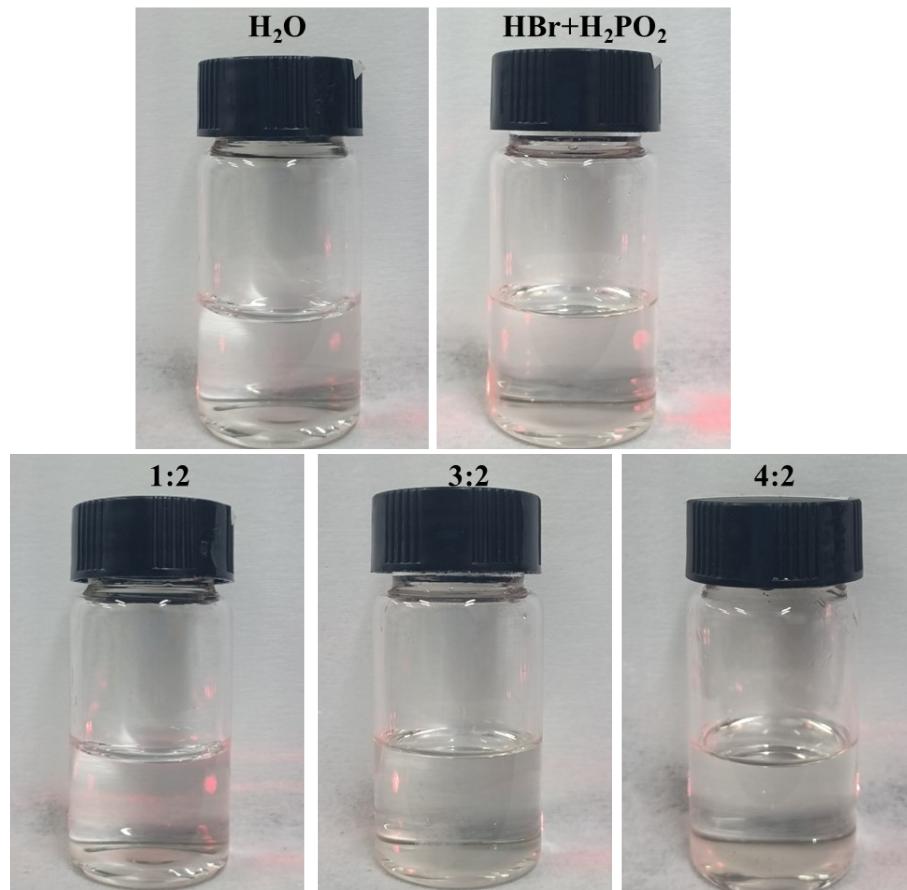


Fig. S1 Tyndall effect in solution

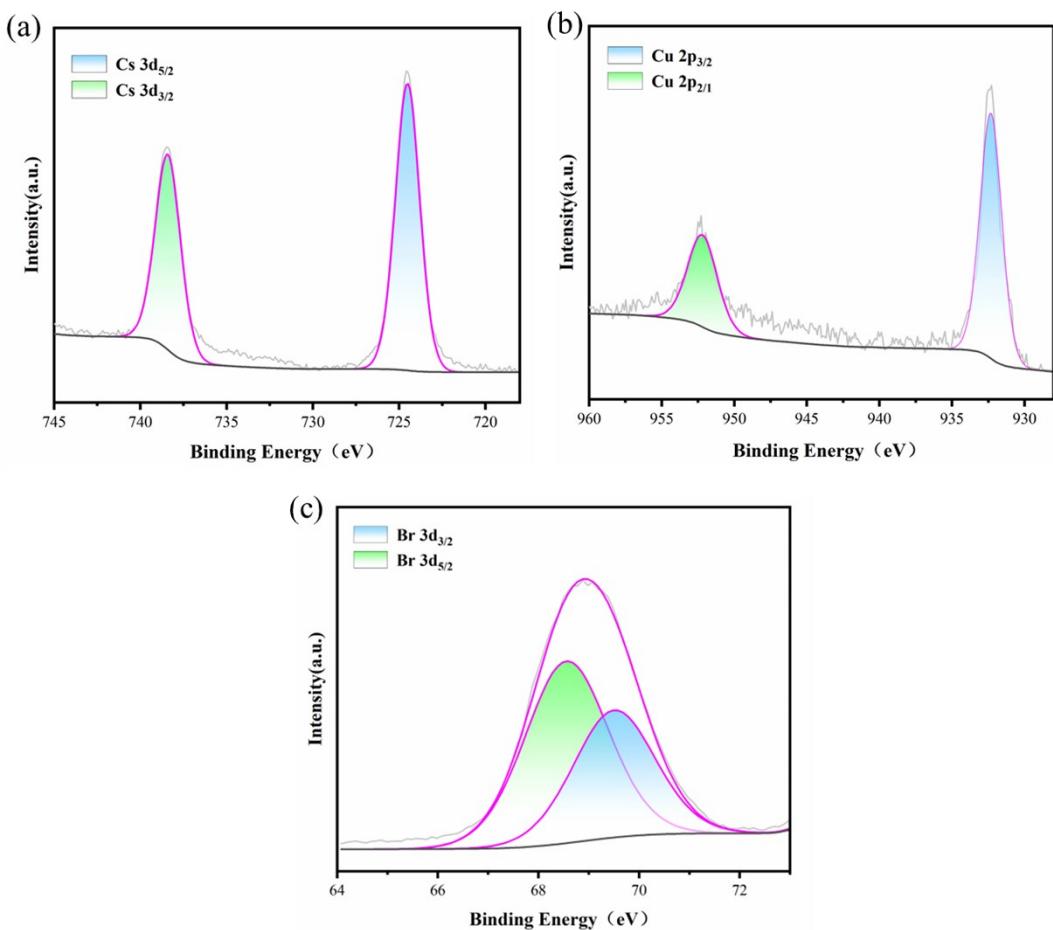


Fig. S2 XPS analysis of (a) Cs 3d, (b) Cu 2p, and (c) Br 3d of $\text{Cs}_3\text{Cu}_2\text{Br}_5$ crystal powder.

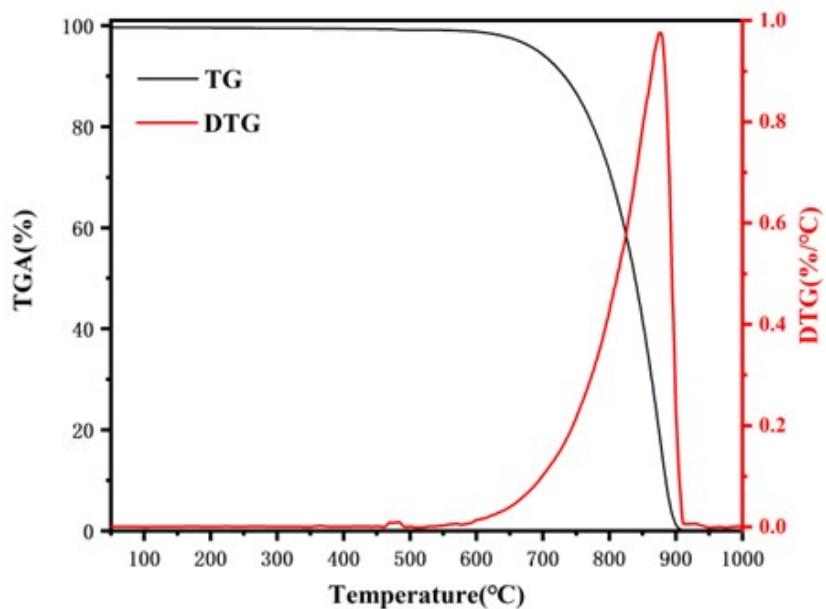
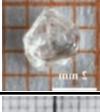
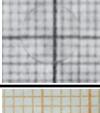
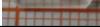


Fig. S3 TG and DTG curves of $\text{Cs}_3\text{Cu}_2\text{Br}_5$.

Table S1 Current research on $\text{Cs}_3\text{Cu}_2\text{Br}_5$ single crystals

Preparation method	Crystal picture	Excitation (nm)	Emission (FWHM) (nm)	TRPL (us)	Light yield (photon·MeV ⁻¹)	Energy resolution	Afterglow	Reference
$\text{Cs}_3\text{Cu}_2\text{Br}_5$	AVC		298	458(80)	15.77	/	/	1
	EC		301	464(78)	20.03	/	/	2
	VB		311	453(69)	13.6	4000	Comparable to BGO	3
CsCu_2Br_3	LTC		310	456(83)	15.6	6384	17.50%	6%@10ms Our work
	LTC		266	580(68)	/	5800	/	0.07 %@3ms Our work

Cooling crystallization method: LTC; Evaporation crystallization method: EC; Bridgman method: VB; Antisolvent method: AVC

 Table S2 the reported research work on $\text{Cs}_3\text{Cu}_2\text{Br}_5$ and CsCu_2Br_3 (non-single crystal)

Sample state	Excitation (nm)	Emission (FWHM) (nm)	TRPL (us)	E_b (meV)	PLQY(%)	Reference
powder	300	460(78)	16.88	/	27.38	4
	298	460(83)	/	630	23	5
	298	455(75)	/	400	50.1	6
	290	461(82)	29	720	17.3	7
$\text{Cs}_3\text{Cu}_2\text{Br}_5$	290	451(93)	/	/	/	8
	290	458(79)	21.69	/	11.6	9
	268	459(85)	18.4	/	6.3	10
	290	451(93)	/	/	/	11
CsCu_2Br_3	film	270	463	/	/	12
	polycrystalline ingots	325	533(106)	0.018	155	13

References

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